NEWS RELEASE
Tokyo Midtown Yaesu , Yaesu Central Tower 2-2-1 Yaesu, Chuo-ku, Tokyo 104-0028, Japan
https://www.mitsuichemicals.com MITSUI CHEMICALS,INC.

November 25, 2026

Mitsui Chemicals, Inc.

Mitsui Chemicals Group to Exhibit at SEMICON® JAPAN 2026

Mitsui Chemicals, Inc. (Tokyo: 4183; President & CEO: ICHIMURA Satoshi), Mitsui Chemicals ICT Materia, Inc. (President & CEO: SAIMOTO Yoshihisa), Honshu Chemical Industry Co., Ltd. (President & CEO: HIRAIWA Takeshi), Mitsui Fine Chemicals, Inc. (President & CEO: TANAKA Hisayoshi), and Mitsui Chemical Analysis & Consulting Service, Inc. (President & CEO: TSURUDA Satoshi), five Mitsui Chemicals Group companies, will exhibit at SEMICON® JAPAN 2026, to be held at Tokyo Big Sight from December 9 to 11, 2026.

At the booth, Mitsui Chemicals Group will present the latest solutions supporting the future of global semiconductor manufacturing across a wide range of processes, including ICROS™ Tape, the world's No. 1 backside wafer grinding protective tape, and Mitsui Pellicle™, a dust-protective cover for photomasks, as well as Paltref™, a fluorine-free, highly heat-resistant release film; PIVAR™, a heat-resistant polyimide resin for temporary bonding; MILEX™, a raw material for photoresists; PFAS alternative solutions; and material analysis solutions.



Exhibition Overview

- Exhibition Name: "SEMICON® JAPAN 2026"
- Duration: December 9 (Wednesday) to 11 (Friday), 2026, 10:00 AM to 5:00 PM
- Venue: Tokyo Big Sight (Tokyo International Exhibition Center), West Hall 2
  Mitsui Chemicals Group Booth W2943 (West Hall 2)
  (Joint booth of Mitsui Chemicals, Mitsui Chemicals ICT Materia, Honshu Chemical Industry, Mitsui Fine Chemicals, and Mitsui Chemical Analysis & Consulting Service)

*Please register in advance on the official SEMICON® Japan website before visiting. Home | SEMICON Japan

Mitsui Chemicals Group Exhibit Information

Products & Solutions	Features / Applications	Responsible Department
MITSUI PELLICE™	Protective covers that shield photomasks from particles during lithography	Mitsui Chemicals, Inc. Semiconductor & Optical Materials Division
Paltref™	Fluorine-free, highly heat-resistant release film	Mitsui Chemicals, Inc. ICT Materials Business Division
PIVAR™	Heat-resistant polyimide resin for temporary bonding processes	Mitsui Chemicals, Inc. ICT Materials Business Division
MILEX™	Photoresist raw materials offering high sensitivity, resolution and durability	Mitsui Chemicals, Inc. ICT Materials Business Division
Olefin-based polymers for the semiconductor market	Heat-resistant, low-dielectric, chemical-resistant resins	Mitsui Chemicals, Inc. Advanced Materials & Solutions Research Laboratory
EPOKEY™	Epoxy resin primer that enhances interfacial adhesion in encapsulation resins and adhesive layers	Mitsui Chemicals, Inc. Coating & Engineering Materials Division
PFAS -Free solution	Alternative proposals using TPX, UHMW-PE, and olefin-based polymers	Mitsui Chemicals, Inc. Planning & Coordination Division
ICROS™ Tape	Tapes for semiconductor manufacturing processes, including back grinding, dicing, and resin encapsulation.	Mitsui Chemicals ICT Materia, Inc.
High thermal conductivity monomers	Resins contributing to heat dissipation in AI semiconductors and power semiconductors	Honshu Chemical Industry Co., Ltd.
Amine compounds for electronic materials	Monomers for polyimide resins and curing agents for epoxy resins	Mitsui Fine Chemicals, Inc.
Semiconductor material analysis solutions	Support from root-cause investigation to countermeasure planning through polymer analysis and analysis of microscopic foreign particles and trace metals	Mitsui Chemical Analysis & Consulting Service, Inc.